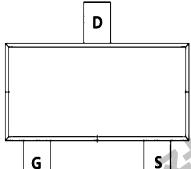
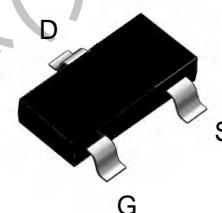
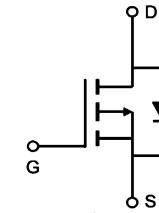


TM06P03I

P-Channel Enhancement Mosfet

| | |
|---|--|
| <p>General Description</p> <ul style="list-style-type: none"> • Low $R_{DS(ON)}$ • RoHS and Halogen-Free Compliant <p>Applications</p> <ul style="list-style-type: none"> • Load switch • PWM | <p>General Features</p> <p>$V_{DS} = -30V$ $I_D = -6.0A$</p> <p>$R_{DS(ON)} = 26m\Omega$ (Typ.) @ $V_{GS} = -10V$</p> <p>100% UIS Tested 100% R_g Tested</p>  |
| <p>I:SOT-23</p>    <p>Marking: 30P06</p> | |

| Absolute Maximum Ratings $T_A = 25^\circ C$ un (less otherwise noted) | | | |
|--|---|---------------|--------------|
| Symbol | Parameter | Rating | Units |
| V_{DS} | Drain-Source Voltage | -30 | V |
| V_{GS} | Gate-Source Voltage | ± 20 | V |
| $I_D @ T_A = 25^\circ C$ | Continuous Drain Current, $V_{GS} @ -10V$ | -6.0 | A |
| $I_D @ T_A = 70^\circ C$ | Continuous Drain Current, $V_{GS} @ -10V$ | -4.5 | A |
| I_{DM} | Pulsed Drain Current | -28 | A |
| $P_D @ T_A = 25^\circ C$ | Total Power Dissipation | 1.5 | W |
| T_{STG} | Storage Temperature Range | -55 to 175 | $^\circ C$ |
| T_J | Operating Junction Temperature Range | -55 to 175 | $^\circ C$ |

| Thermal Data | | | | |
|---------------------|-------------------------------------|-------------|-------------|--------------|
| Symbol | Parameter | Typ. | Max. | Unit |
| $R_{\theta JA}$ | Thermal Resistance Junction-ambient | --- | 125 | $^\circ C/W$ |
| $R_{\theta JC}$ | Thermal Resistance Junction-Case | --- | --- | $^\circ C/W$ |

TM06P03I
P-Channel Enhancement Mosfet
Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise specified)

| Symbol | Parameter | Test Condition | Min. | Typ. | Max. | Units |
|---|--|---|------|------|-----------|------------------|
| Off Characteristic | | | | | | |
| $V_{(\text{BR})\text{DSS}}$ | Drain-Source Breakdown Voltage | $V_{GS}=0\text{V}, I_D = -250\mu\text{A}$ | -30 | - | - | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = -30\text{V}, V_{GS}=0\text{V},$ | - | - | -1 | μA |
| I_{GSS} | Gate to Body Leakage Current | $V_{DS}=0\text{V}, V_{GS} = \pm 20\text{V}$ | - | - | ± 100 | nA |
| On Characteristics | | | | | | |
| $V_{GS(\text{th})}$ | Gate Threshold Voltage | $V_{DS}=V_{GS}, I_D = -250\mu\text{A}$ | -1.0 | -1.5 | -2.0 | V |
| $R_{DS(\text{on})}$ note3 | Static Drain-Source on-Resistance | $V_{GS} = -10\text{V}, I_D = -7\text{A}$ | - | 26 | 33 | $\text{m}\Omega$ |
| | | $V_{GS} = -4.5\text{V}, I_D = -4\text{A}$ | - | 34 | 44 | |
| Dynamic Characteristics | | | | | | |
| C_{iss} | Input Capacitance | $V_{DS} = -15\text{V}, V_{GS}=0\text{V}, f=1.0\text{MHz}$ | - | 782 | - | pF |
| C_{oss} | Output Capacitance | | - | 135 | - | pF |
| C_{rss} | Reverse Transfer Capacitance | | - | 109 | - | pF |
| Q_g | Total Gate Charge | $V_{DS} = -15\text{V}, I_D = -4\text{A}, V_{GS} = -10\text{V}$ | - | 10 | - | nC |
| Q_{gs} | Gate-Source Charge | | - | 2 | - | nC |
| Q_{gd} | Gate-Drain("Miller") Charge | | - | 2.7 | - | nC |
| Switching Characteristics | | | | | | |
| $t_{d(on)}$ | Turn-on Delay Time | $V_{DD} = -15\text{V}, I_D = -7\text{A}, V_{GS} = -10\text{V}, R_{GEN} = 2.5\Omega$ | - | 11 | - | ns |
| t_r | Turn-on Rise Time | | - | 19 | - | ns |
| $t_{d(off)}$ | Turn-off Delay Time | | - | 45 | - | ns |
| t_f | Turn-off Fall Time | | - | 26 | - | ns |
| Drain-Source Diode Characteristics and Maximum Ratings | | | | | | |
| I_s | Maximum Continuous Drain to Source Diode Forward Current | - | - | -6 | - | A |
| I_{SM} | Maximum Pulsed Drain to Source Diode Forward Current | - | - | -28 | - | A |
| V_{SD} | Drain to Source Diode Forward Voltage | $V_{GS}=0\text{V}, I_s = -7\text{A}$ | - | -0.8 | -1.2 | V |

Typical Performance Characteristics

Figure 1: Output Characteristics

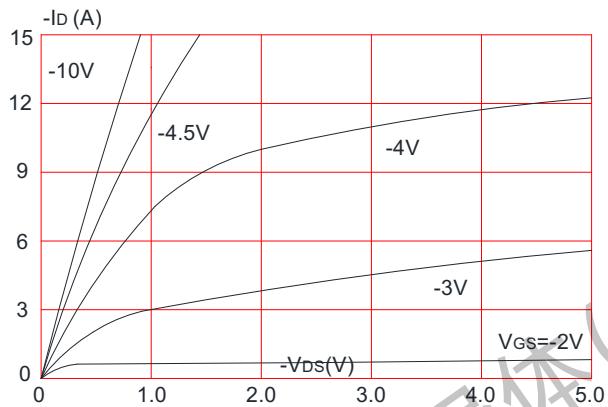


Figure 3: On-resistance vs. Drain Current

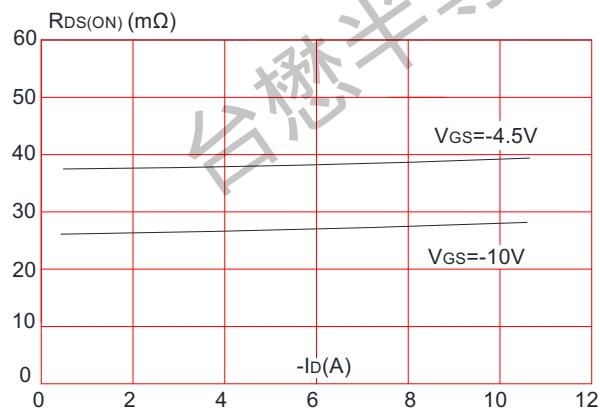


Figure 5: Gate Charge Characteristics

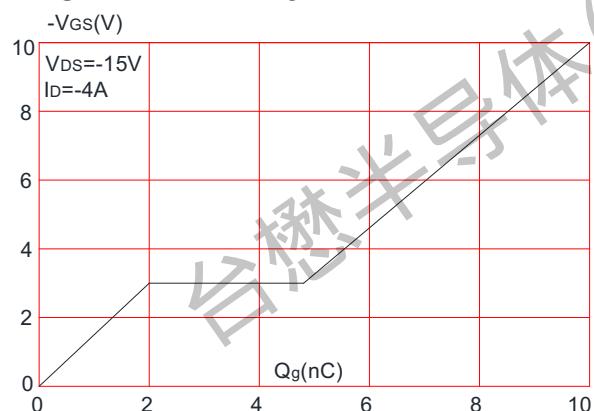


Figure 2: Typical Transfer Characteristics

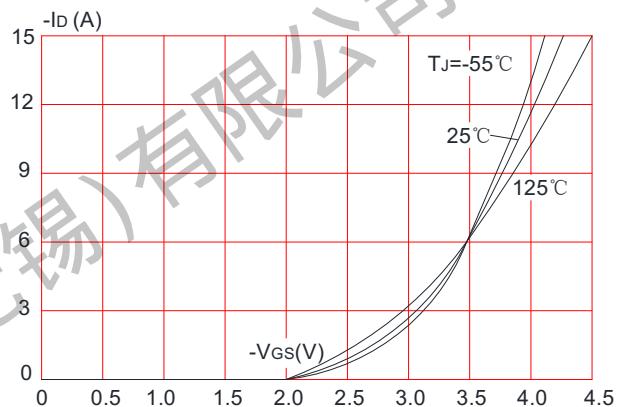


Figure 4: Body Diode Characteristics

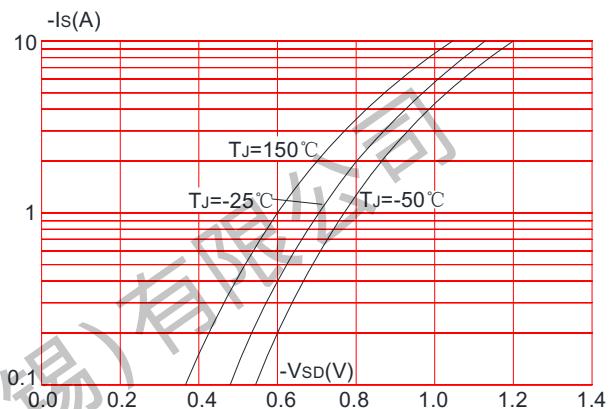
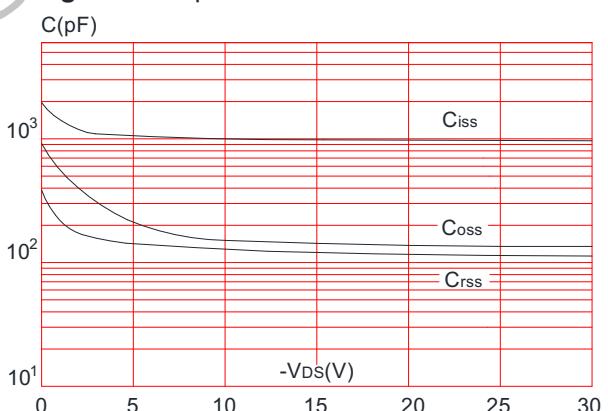


Figure 6: Capacitance Characteristics



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Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

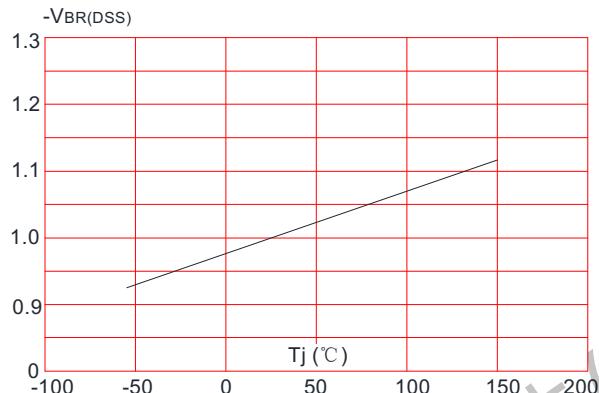


Figure 8: Normalized on Resistance vs. Junction Temperature

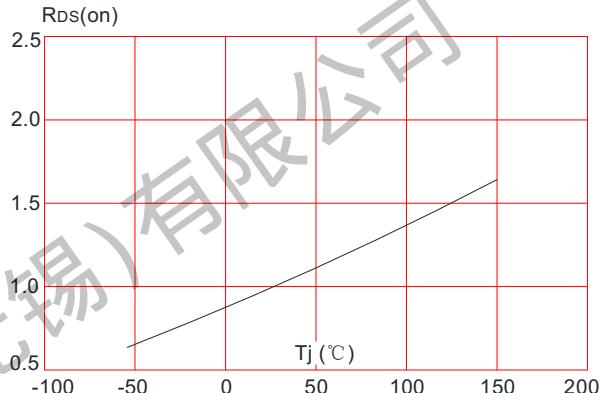


Figure 9: Maximum Safe Operating Area

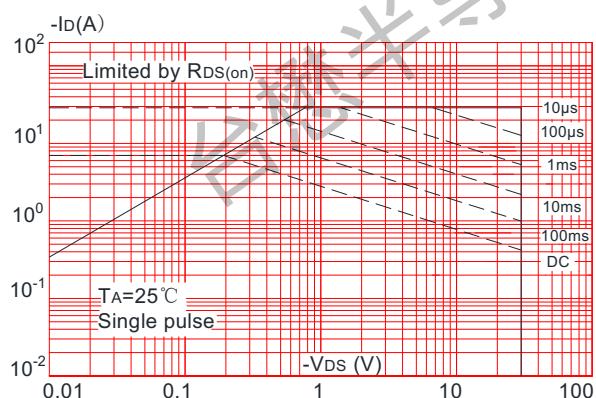
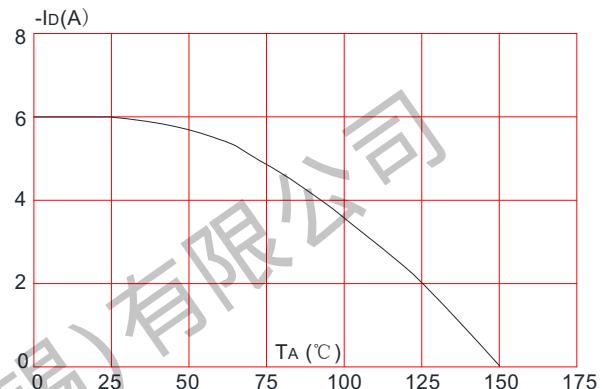
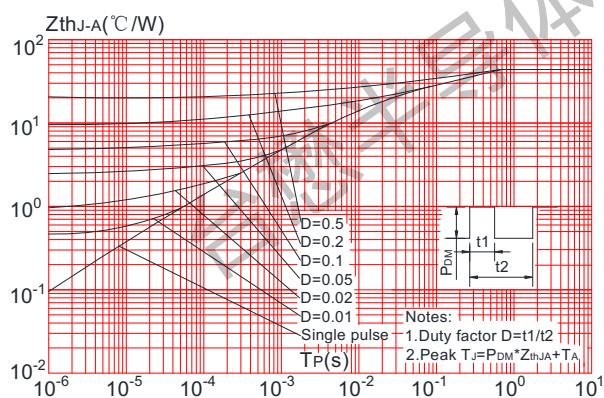


Figure 10: Maximum Continuous Drain Current vs. Ambient Temperature



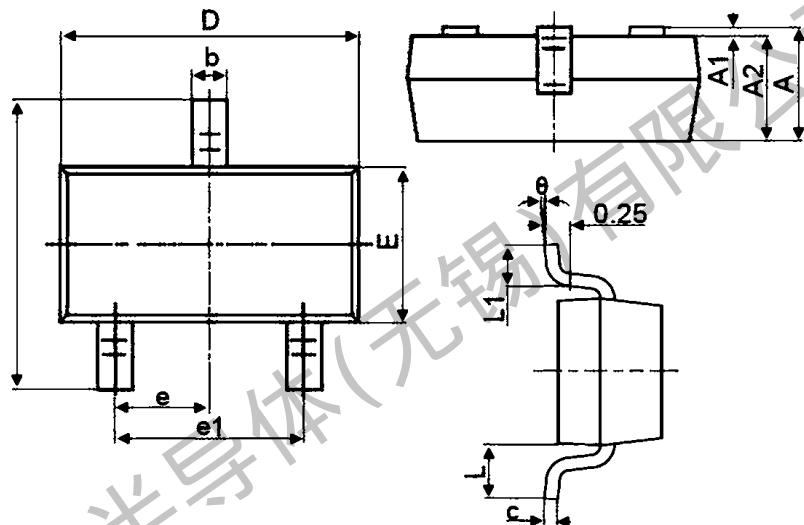
Maximum Effective
Transient Thermal Impedance, Junction-to-Ambient



TM06P03I

P-Channel Enhancement Mosfet

Package Mechanical Data:SOT-23



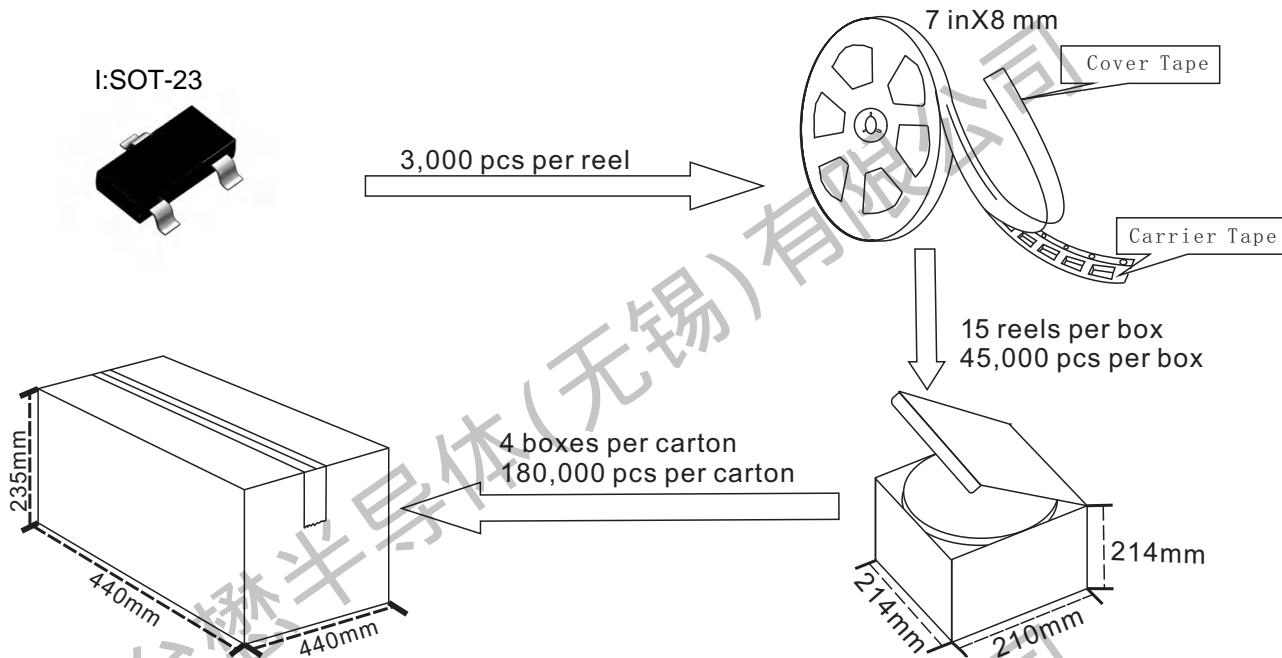
| Symbol | Dimensions in Millimeters | |
|--------|---------------------------|-------|
| | MIN. | MAX. |
| A | 0.900 | 1.150 |
| A1 | 0.000 | 0.100 |
| A2 | 0.900 | 1.050 |
| b | 0.300 | 0.500 |
| c | 0.080 | 0.150 |
| D | 2.800 | 3.000 |
| E | 1.200 | 1.400 |
| E1 | 2.250 | 2.550 |
| e | 0.950TYP | |
| e1 | 1.800 | 2.000 |
| L | 0.550REF | |
| L1 | 0.300 | 0.500 |
| θ | 0° | 8° |

TM06P03I

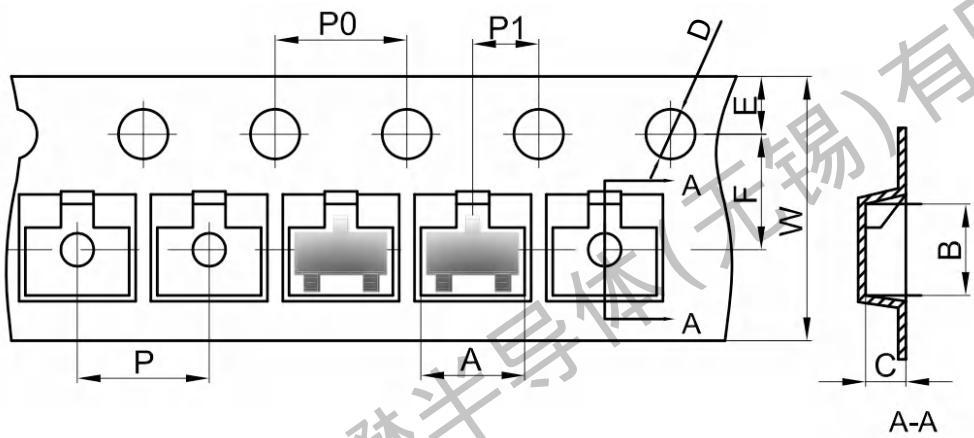
P-Channel Enhancement Mosfet

SOT-23 Packing

1. The method of packaging and dimension are shown as below figure. (Dimension in mm)

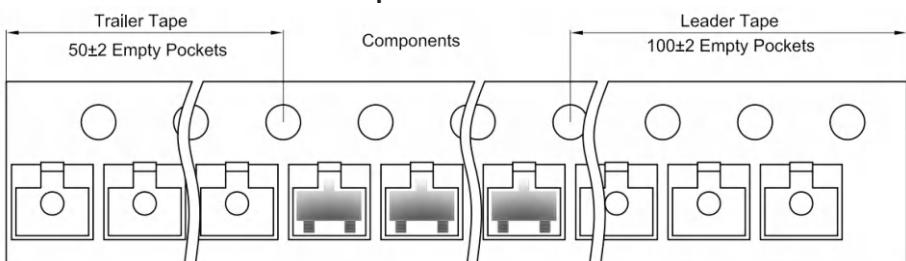


SOT-23 Embossed Carrier Tape



| Dimensions are in millimeter | | | | | | | | | | |
|------------------------------|------|------|------|-------|------|------|------|------|------|------|
| Pkg type | A | B | C | D | E | F | P0 | P | P1 | W |
| SOT-23 | 3.15 | 2.77 | 1.22 | Ø1.50 | 1.75 | 3.50 | 4.00 | 4.00 | 2.00 | 8.00 |

SOT-23 Tape Leader and Trailer



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| 2023.07.09 | 23.07 | Original | |